

<u>B270 - B2100</u>

SMB

Min

3.30

4.06

Max

3.94

4.57

2.21

0.31

5.59

0.20

1.52

2.62

Dim

Α

в

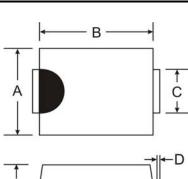
2.0A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER

Features

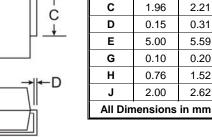
- Schottky Barrier Chip
- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Surge Overload Rating to 50A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- High Temperature Soldering: 260°C/10 Second at Terminal
- Lead Free Finish/RoHS Compliant (Note 3)

Mechanical Data

- Case: SMB •
- Case Material: Molded Plastic. UL Flammability • Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 @3
- Polarity: Cathode Band or Cathode Notch
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.093 grams (approximate)



G



Maximum Ratings and Electrical Characteristics @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

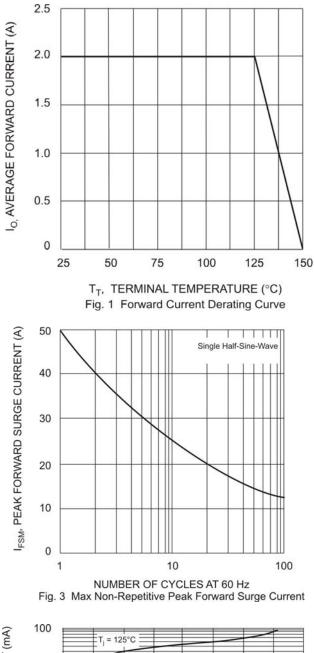
| Characteristic | | Symbol | B270 | B280 | B290 | B2100 | Unit |
|---|---|--|--------------|------|------|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | | V _{RRM} V _{RWM} V _R | 70 | 80 | 90 | 100 | V |
| RMS Reverse Voltage | | V _{R(RMS)} | 49 | 56 | 63 | 70 | V |
| Average Rectified Output Current | @ T _T = 125°C | lo | 2.0 | | | А | |
| Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load | | I _{FSM} | 50 | | А | | |
| Forward Voltage @ $I_F = 2.0A$ | @ T _A = 25°C @ T _A = 100°C | V _{FM} | 0.79 0.69 | | V | | |
| Peak Reverse Current at Rated DC Blocking Voltage | @ T _A = 25°C @ T _A = 100°C | I _{RM} | 0.5 15 | | mA | | |
| Typical Total Capacitance (Note 2) | | CT | | 7 | 5 | | pF |
| Typical Thermal Resistance Junction to Terminal (Note 1) | | R _{θJT} | 15 | | °C/W | | |
| Operating and Storage Temperature Range | | T _{j,} T _{STG} | -65 to +150 | | °C | | |

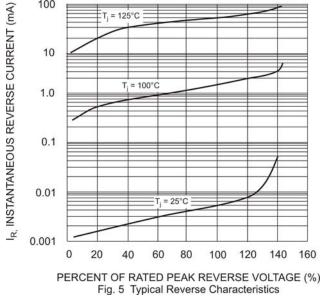
Notes: Valid provided that terminals are kept at ambient temperature. 1.

Measured at 1.0 MHz and applied reverse voltage of 4.0V DC. 2.

3 RoHS revision 13.2.2003. Glass and high temperature solder exemptions applied, see EU Directive Annex Notes 5 and 7.







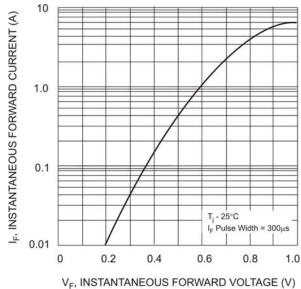
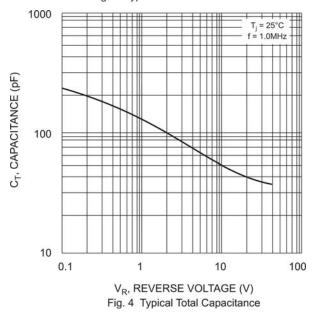


Fig. 2 Typical Forward Characteristics





Ordering Information (Note 4)

| Device* | Packaging | Shipping | |
|------------|-----------|------------------|--|
| B2xxx-13-F | SMB | 3000/Tape & Reel | |

* x = Device type, e.g. B270-13-F

Notes: 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



XXXX = Product type marking code, ex: B290 (SMB package))!! = Manufacturers' code marking YWW = Date code marking Y = Last digit of year ex: 2 for 2002 WW = Week code 01 to 52

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.